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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No.:	09/975,444	Confirmation No.	9172
Applicant:	Ching-Te Lin et al.	Filed:	10/11/2001
TC/A.U.:	2814	Examiner:	Long Pham
Docket No.:	TI-31518	Customer No.:	23494

Title: ELIMINATION OF OVERHANG IN LINER/BARRIER/SEED
LAYERS USING POST-DEPOSITION SPUTTER ETCH

CERTIFICATION OF FACSIMILE TRANSMISSION	
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NAME OF INVENTOR(S):	
Lin et al	
TITLE OF INVENTION:	
Elimination of Overhang in Liner . . .	
TI FILE NO.:	DEPOSIT ACCT. NO.:
TI-31518	20-0668
FAXED: 10/20/2003	
DUE: 8/20/2003	
ATTY/SECY: JJG	
RECEIPT DATE & SERIAL NO.:	
Serial No.: 09/975,444	
Filing Date: 10/11/2001	

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